

## GB05SLT12-220

# Silicon Carbide Power Schottky Diode

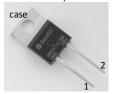
## $V_{RRM}$ = 1200 V $I_{F (Tc = 25^{\circ}C)}$ = 12 A $Q_{C}$ = 21 nC

#### **Features**

- 1200 V Schottky rectifier
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- · Superior surge current capability
- Positive temperature coefficient of V<sub>F</sub>
- Extremely fast switching speeds
- Superior figure of merit Q<sub>C</sub>/I<sub>F</sub>

#### **Package**

RoHS Compliant





TO - 220AC

## **Advantages**

- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- · Smaller heat sink requirements
- Low reverse recovery current
- · Low device capacitance
- Low reverse leakage current at operating temperature

## **Applications**

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- · Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

## Maximum Ratings at T<sub>i</sub> = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$		1200	V	
Continuous forward current	I <sub>F</sub>	T <sub>C</sub> ≤ 155 °C	5	Α	
RMS forward current	I <sub>F(RMS)</sub>	T <sub>C</sub> ≤ 155 °C	8	Α	
Surge non-repetitive forward current, Half Sine	1	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	32	۸	
Wave	I <sub>F,SM</sub>	$T_C = 155 ^{\circ}\text{C},  t_P = 10 \text{ms}$	26	A	
Non-repetitive peak forward current	I <sub>F,max</sub>	$T_C$ = 25 °C, $t_P$ = 10 $\mu$ s	120	Α	
l <sup>2</sup> t value	∫i² dt	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	5	A <sup>2</sup> s	
i i value		$T_C$ = 155 °C, $t_P$ = 10 ms	3.4		
Power dissipation	P <sub>tot</sub>	T <sub>C</sub> = 25 °C	117	W	
Operating and storage temperature	$T_{j}$ , $T_{stg}$		-55 to 175	°C	

## Electrical Characteristics at $T_j$ = 175 °C, unless otherwise specified

Parameter	Symbol	Conditions min.		Values		Unit	
	Syllibol			typ.	max.	Ulill	
Diode forward voltage	V <sub>F</sub>	I <sub>F</sub> = 5 A, T <sub>j</sub> = 25 °C		1.6	1.9	V	
	VF	$I_F = 5 \text{ A}, T_j = 175 ^{\circ}\text{C}$		2.6	3.0		
Reverse current	1	V <sub>R</sub> = 1200 V, T <sub>j</sub> = 25 °C		5	50	μA	
	I <sub>R</sub>	$V_R = 1200 \text{ V}, T_j = 175 ^{\circ}\text{C}$		10	100		
Total capacitive charge	0	V <sub>R</sub> = 400 V			21		nC
	$Q_{C}$	$I_F \le I_{F,MAX}$ $dI_F/dt = 200 \text{ A/}\mu\text{s}$	V <sub>R</sub> = 960 V		35		110
Switching time		T <sub>i</sub> = 175 °C	V <sub>R</sub> = 400 V		< 25		
	t <sub>s</sub>	V <sub>R</sub> = 960 V		\ 23		ns	
Total capacitance		$V_R = 1 \text{ V, f} = 1 \text{ MHz, T}_j = 25 \text{ °C}$		260		_	
	С	$V_R = 400 \text{ V}, f = 1 \text{ MHz}, T_j = 25 ^{\circ}\text{C}$		25		pF	
		$V_R = 1000 \text{ V}, f = 1 \text{ MHz}, T_j = 25 ^{\circ}\text{C}$		20			

#### **Thermal Characteristics**

Thermal resistance, junction - case	R <sub>thJC</sub>	1.4	°C/W
Mechanical Properties			
Mounting torque	M	0.6	Nm



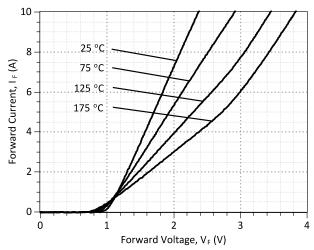


Figure 1: Typical Forward Characteristics

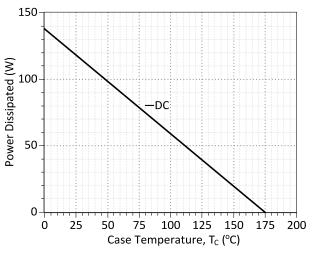


Figure 3: Power Derating Curve

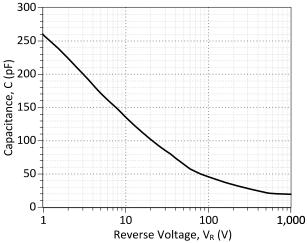


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics

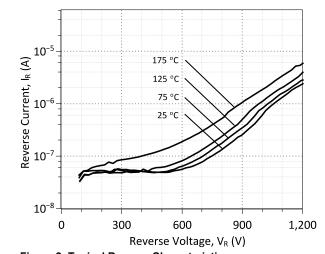


Figure 2: Typical Reverse Characteristics

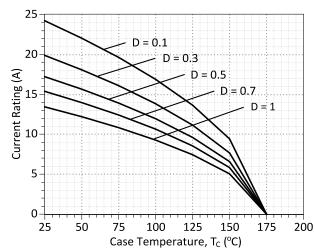


Figure 4: Current Derating Curves (D =  $t_P/T$ ,  $t_P$ = 400 µs) (Considering worst case  $Z_{th}$  conditions )

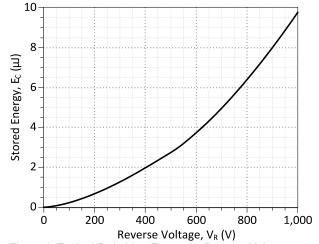


Figure 6: Typical Switching Energy vs Reverse Voltage Characteristics



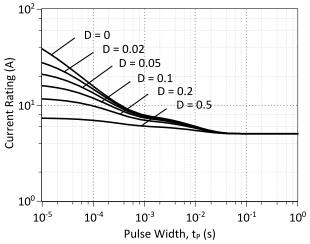


Figure 7: Current vs Pulse Duration Curves at T<sub>C</sub> = 155 °C

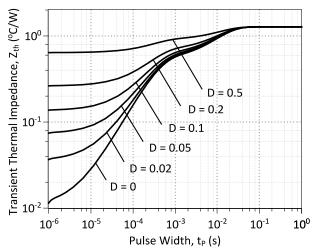
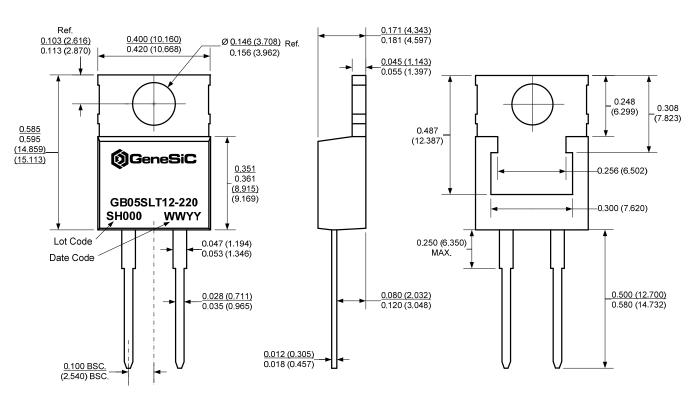


Figure 8: Transient Thermal Impedance

#### **Package Dimensions:**

## TO-220AC

### **PACKAGE OUTLINE**



#### NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



Revision History					
Date	Revision	Comments	Supersedes		
2014/08/26	3	Updated Electrical Characteristics			
2013/02/05	2	Second generation update			
2012/05/22	1	Second generation release			
2010/12/14	0	Initial release			

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### **SPICE Model Parameters**

Copy the following code into a SPICE software program for simulation of the GB05SLT12-220 device.

```
MODEL OF GeneSiC Semiconductor Inc.
    $Revision: 1.0
     $Date: 04-SEP-2013
    GeneSiC Semiconductor Inc.
     43670 Trade Center Place Ste. 155
    Dulles, VA 20166
    http://www.genesicsemi.com/index.php/sic-products/schottky
    COPYRIGHT (C) 2013 GeneSiC Semiconductor Inc.
    ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of GB05SLT12-220 SPICE Model
.SUBCKT GB05SLT12 ANODE KATHODE
R1 ANODE INT R=((TEMP-24)*0.0015); Temperature Dependant Resistor
D1 INT KATHODE GB05SLT12 25C; Call the 25C Diode Model
D2 ANODE KATHODE GB05SLT12 PIN; Call the PiN Diode Model
.MODEL GB05SLT12 25C D
+ IS 5.83E-18
                                    0.1276
                         RS
+ N
         1
                         IKF
                                    602
         1.2
+ EG
                         XTI
+ CJO
                                    0.419
         3.00E-10
                        VJ
+ M
         1.6
                         FC
                                    0.5
+ TT
        1.00E-10
1.00E-03
                        BV
                                    1200
+ IBV
                         VPK
                                   1200
                                   SiC Schottky
+ IAVE
                          TYPE
+ MFG GeneSiC Semiconductor
.MODEL GB05SLT12 PIN D
      3.50 E-12
                                   0.3648
+ IS
                        RS
+ N
         4.409
                                    73
                         IKF
+ EG
         3.23
                        XTI
                                    -6
+ FC
         0.5
                         TT
+ BV
         1200
                         IBV
                                   1.00E-03
+ VPK
         1200
                         IAVE
+ TYPE SiC_PiN
.ENDS
```

<sup>\*</sup> End of GB05SLT12-220 SPICE Model